Chipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

8 GHz max. capable, 1 W carrying power (at 5 GHz), 50Ω impedance and 2 Form C relays	RJ RELAYS (ARJ)
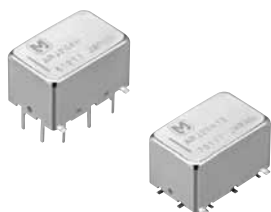
RoHS compliant

FEATURES

- **Excellent high frequency characteristics (50Ω, at 5GHz)**
  V.S.W.R.: Max. 1.25
  Insertion loss: Max. 0.5dB
  Isolation: Min. 35dB
  (Between open contacts)
  Min. 30dB
  (Between contact sets)
- **Surface mount terminal**
  Surface mount terminals are now standard so there is much less work in designing PC boards.
- **Small size**
  Size: 14.00 (L)×9.00 (W)×8.20 (H) mm
  .551 (L)×.354 (W)×.323 (H) inch

TYPICAL APPLICATIONS

- **Measuring equipment market**
  Attenuator circuits, spectrum analyzer, oscilloscope, Telecommunication equipment and tester inspection.
- **Network communications market**
  Microwave communication
- **Medical instrument market**

If you consider using applications with low level loads or with high frequency switching, please consult us.

ORDERING INFORMATION

ARJ 2 ☐ ☐ ☐ ☐ ☐

RJ relays

Contact arrangement
2: 2 Form C

Operating function
0: Single side stable
2: 2 coil latching

Terminal shape
Nil: Standard PC board terminal
A: Surface-mount terminal

Coil voltage (DC)
03: 3V, 4H: 4.5V, 12: 12V, 24: 24V (H=0.5)

Packing style
Nil: Carton packing
X: Tape and reel packing (picked from 1/2/3-pin side)
Z: Tape and reel packing (picked from 6/7/8-pin side)

TYPES

1. Standard PC board terminal

Contact arrangement	Nominal coil voltage	Part No.	
		Single side stable	2 coil latching
2 Form C	3 V DC	ARJ2003	ARJ2203
	4.5 V DC	ARJ204H	ARJ224H
	12 V DC	ARJ2012	ARJ2212
	24 V DC	ARJ2024	ARJ2224

Standard packing: 50 pcs. in an inner package; 500 pcs. in an outer package

2. Surface-mount terminal
1) Carton packing

Contact arrangement	Nominal coil voltage	Part No.	
		Single side stable	2 coil latching
2 Form C	3 V DC	ARJ20A03	ARJ22A03
	4.5 V DC	ARJ20A4H	ARJ22A4H
	12 V DC	ARJ20A12	ARJ22A12
	24 V DC	ARJ20A24	ARJ22A24

Standard packing: 50 pcs. in an inner package; 500 pcs. in an outer package

2) Tape and reel packing

Contact arrangement	Nominal coil voltage	Part No.	
		Single side stable	2 coil latching
2 Form C	3 V DC	ARJ20A03Z	ARJ22A03Z
	4.5 V DC	ARJ20A4HZ	ARJ22A4HZ
	12 V DC	ARJ20A12Z	ARJ22A12Z
	24 V DC	ARJ20A24Z	ARJ22A24Z

Standard packing: 500 pcs. in an inner package; 1,000 pcs. in an outer package
Note: Tape and reel packing symbol "-Z" is not marked on the relay. "X" type tape and reel packing (picked from 1/2/3-pin side) is also available. Suffix "X" instead of "Z".

RATING

1. Coil data

1) Single side stable

Nominal coil voltage	Pick-up voltage (at 20°C 68°F)	Drop-out voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. applied voltage (at 70°C 158°F)
3 V DC	75%V or less of nominal voltage (Initial)	10%V or more of nominal voltage (Initial)	66.6 mA	45 Ω	200 mW	110%V of nominal voltage
4.5 V DC			44.4 mA	101.2 Ω		
12 V DC			16.6 mA	720 Ω		
24 V DC			8.3 mA	2,880 Ω		

2) 2 coil latching

Nominal coil voltage	Set voltage (at 20°C 68°F)	Reset voltage (at 20°C 68°F)	Nominal operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Nominal operating power	Max. applied voltage (at 70°C 158°F)
3 V DC	75%V or less of nominal voltage (Initial)	75%V or less of nominal voltage (Initial)	50 mA	60 Ω	150 mW	110%V of nominal voltage
4.5 V DC			33.3 mA	135 Ω		
12 V DC			12.5 mA	960 Ω		
24 V DC			6.3 mA	3,840 Ω		

2. Specifications

Characteristics	Item		Specifications
Contact	Arrangement		2 Form C
	Contact material		Gold plating
	Initial contact resistance, max.		Max. 150mΩ (By voltage drop 10V DC 10mA)
Rating	Contact rating		1W (at 5GHz, Impedance 50Ω, V.S.W.R. ≦ 1.25) 10mA 10V DC (resistive load)
	Contact carrying power		1W (at 5GHz, Impedance 50Ω, V.S.W.R. ≦ 1.25)
	Max. switching voltage		30V DC
	Max. switching current		0.3A DC
	Nominal operating power		Single side stable: 200mW, 2 coil latching: 150mW
High frequency characteristics (Initial) (~5GHz, Impedance 50Ω)	V.S.W.R.		Max. 1.25
	Insertion loss (without D.U.T. board's loss)		Max. 0.5dB
	Isolation	Between open contacts	Min. 35dB
		Between contact sets	Min. 30dB
	Input power		1W (at 5GHz, impedance 50Ω, V.S.W.R. ≦ 1.25, at 20°C)
Electrical characteristics	Insulation resistance (Initial)		Min. 500MΩ (at 500V DC) Measurement at same location as "Initial breakdown voltage" section.
	Breakdown voltage (Initial)	Between open contacts	500 Vrms for 1min. (Detection current: 10mA)
		Between contact sets	500 Vrms for 1min. (Detection current: 10mA)
		Between contact and coil	500 Vrms for 1min. (Detection current: 10mA)
		Between coil and earth terminal	500 Vrms for 1min. (Detection current: 10mA)
		Between contact and earth terminal	500 Vrms for 1min. (Detection current: 10mA)
	Temperature rise (at 20°C)		Max. 50°C (By resistive method, nominal voltage applied to the coil, 5GHz, V.S.W.R. ≦ 1.25)
	Operate time [Set time] (at 20°C)		Max. 5ms (Nominal operating voltage applied to the coil, excluding contact bounce time.)
	Release time [Reset time] (at 20°C)		Max. 5ms (Nominal operating voltage applied to the coil, excluding contact bounce time.) (without diode)
Mechanical characteristics	Shock resistance	Functional	Min. 500 m/s² (Half-wave pulse of sine wave: 6ms; detection time: 10μs.)
		Destructive	Min. 1,000 m/s² (Half-wave pulse of sine wave: 11ms.)
	Vibration resistance	Functional	10 to 55 Hz at double amplitude of 3mm (Detection time: 10μs.)
		Destructive	10 to 55 Hz at double amplitude of 5mm
Expected life	Mechanical		Min. 10⁷ (at 180 cpm)
	Electrical		Min. 10⁶ (at 20 cpm) (1W, at 5GHz, V.S.W.R. ≦ 1.25) Min. 10⁶ (at 20 cpm) (10mA 10V DC resistive load)
Conditions	Conditions for operation, transport and storage*		Ambient temperature: –30°C to +70°C –22°F to +158°F Humidity: 5 to 85% R.H. (Not freezing and condensing at low temperature)
Unit weight			Approx. 3 g .11 oz

Note: * The upper operation ambient temperature limit is the maximum temperature that can satisfy the coil temperature rise value. Refer to "AMBIENT ENVIRONMENT" in GENERAL APPLICATION GUIDELINES.
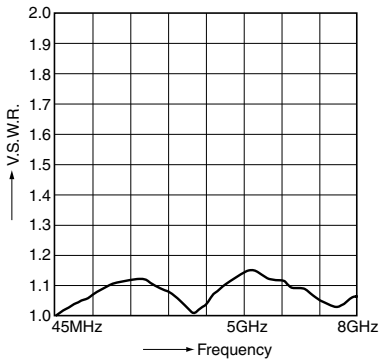
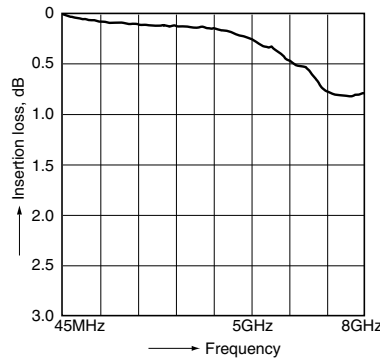# REFERENCE DATA

1. High frequency characteristics

Sample: ARJ20A12

Measuring method: Measured by using our PC board for measurement and HP network analyzer (HP8510C).
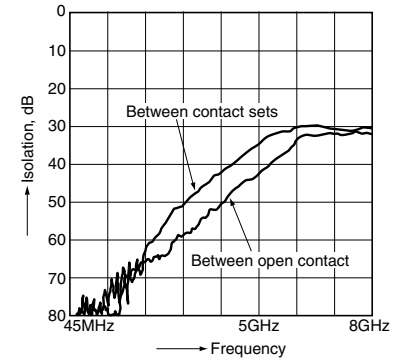
• V.S.W.R. characteristics

• Insertion loss characteristics (without D.U.T. board's loss)
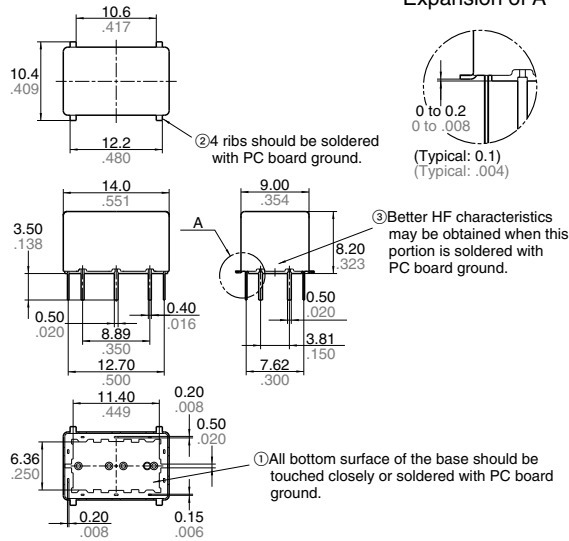
• Isolation characteristics

DIMENSIONS (mm inch)

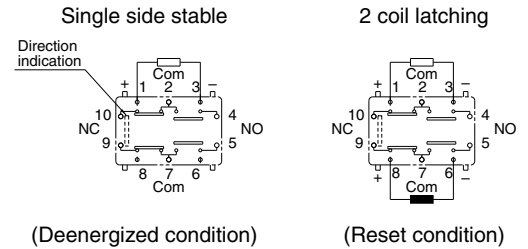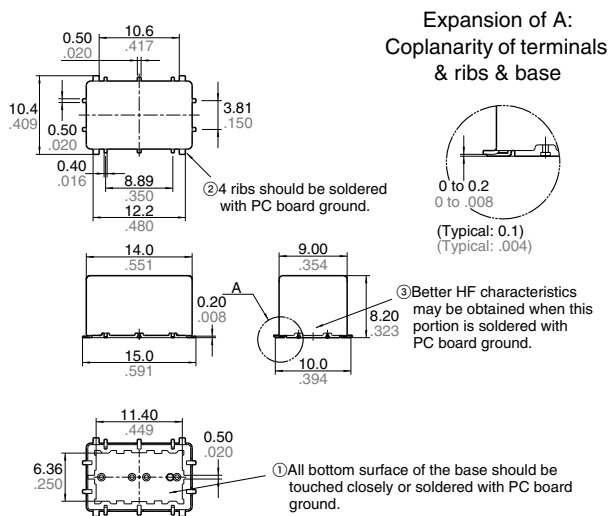The CAD data of the products with a **CAD Data** mark can be downloaded from: http://industrial.panasonic.com/ac/e/

1. Standard PC board terminal

CAD Data

10.6 .417

10.4 .409

12.2 .480

②4 ribs should be soldered with PC board ground.

14.0 .551

3.50 .138

A

9.00 .354

8.20 .323

③Better HF characteristics may be obtained when this portion is soldered with PC board ground.

0.50 .020

0.40 .016

8.89 .350

0.50 .020

3.81 .150

12.70 .500

7.62 .300

11.40 .449

0.20 .008

0.50 .020

6.36 .250

①All bottom surface of the base should be touched closely or soldered with PC board ground.

0.20 .008

0.15 .006

Expansion of A

0 to 0.2
0 to .008

(Typical: 0.1)
(Typical: .004)

Schematic (Bottom view)

Single side stable

Direction indication

+ 1 Com 2 3 −

NC 10 9 4 NO 5

8 7 6

Com

(Deenergized condition)

2 coil latching

Com

+ 1 2 3 −

NC 10 9 4 NO 5

+ 8 7 6 −

Com

(Reset condition)

General tolerance: ±0.3 ±.012

2. Surface mount terminal

CAD Data

0.50 .020

10.6 .417

10.4 .409

0.50 .020

3.81 .150

0.40 .016

8.89 .350

②4 ribs should be soldered with PC board ground.

12.2 .480

14.0 .551

A

0.20 .008

9.00 .354

8.20 .323

③Better HF characteristics may be obtained when this portion is soldered with PC board ground.

15.0 .591

10.0 .394

11.40 .449

0.50 .020

6.36 .250

①All bottom surface of the base should be touched closely or soldered with PC board ground.

Expansion of A:
Coplanarity of terminals & ribs & base

0 to 0.2
0 to .008

(Typical: 0.1)
(Typical: .004)

Schematic (Top view)

Single side stable

Direction indication

8 7 6 Com

9 5
NC 10 4 NO

+ 1 2 3 +
Com

(Deenergized condition)

2 coil latching

+ 8 7 6 + Com

9 5
NC 10 4 NO

+ 1 2 3 +
Com

(Reset condition)

General tolerance: ±0.3 ±.012

Note: Please consult us regarding recommended PC board patterns.

NOTES

1. Coil operating power
Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%. However, check it with the actual circuit since the characteristics may be slightly different. The nominal operating voltage should be applied to the coil for more than 20 ms to set/reset the latching type relay.

2. Coil connection
When connecting coils, refer to the wiring diagram to prevent mis-operation or malfunction.

3. External magnetic field
Since RJ relays are highly sensitive polarized relays, their characteristics will be affected by a strong external magnetic field. Avoid using the relay under that condition.

4. Cleaning
For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick.
It is recommended that alcoholic solvents be used.

5. Tape and reel packing
1) Tape dimensions

(General tolerance: ±0.1 ±.004)
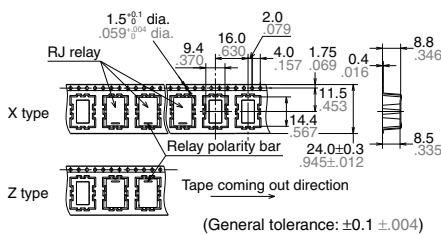
2) Dimensions of plastic reel
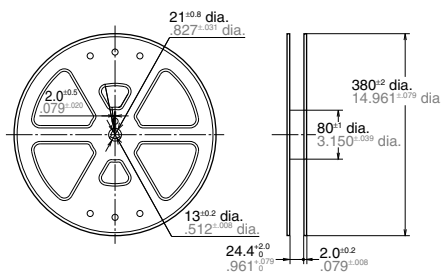
6. Conditions for operation, transport and storage conditions
1) Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:
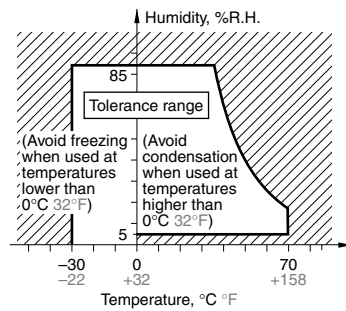(1) Temperature:
−30 to +70°C −22 to +158°F
(However, tolerance range is −30 to +60°C −22 to +140°F if package is carried as is.)
(2) Humidity: 5 to 85% RH
(Avoid freezing and condensation.)
The humidity range varies with the temperature. Use within the range indicated in the graph below.
(3) Atmospheric pressure: 86 to 106 kPa
Temperature and humidity range for usage, transport, and storage:

2) Condensation
Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation.
3) Freezing
Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags.
4) Low temperature, low humidity environments
The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.
5) Storage procedures for surface-mount terminal types
Since the relay is very sensitive to humidity, it is packed in humidity-free, hermetically sealed packaging. When storing the relay, be careful of the following points:
(1) Be sure to use the relay immediately after removing it from its sealed package.
(2) When storing the relay for long periods of time after removing it from its sealed package, we recommend using a humidity-free bag with silica gel to prevent subjecting the relay to humidity. Furthermore, if the relay is solder mounted when it has been subjected to excessive humidity, cracks and leaks can occur. Be sure to mount the relay under the required mounting conditions.
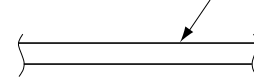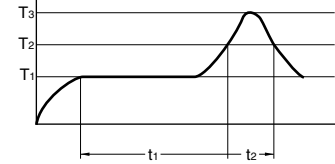
7. Soldering
1) Surface-mount terminal
In case of automatic soldering, the following conditions should be observed
(1) Position of measuring temperature

Surface of PC board where relay is mounted.

(2) IR (infrared reflow) soldering method

T_1 = 150 to 180°C 302 to 356°F t_1 = 60 to 120 sec.
T_2 = 230°C 446°F and higher t_2 = Within 30 sec.
T_3 = Within 250°C 482°F

Temperature rise of relay itself may vary according to the mounting level or the heating method of reflow equipment. Therefore, please set the temperature of soldering portion of relay terminal and the top surface of the relay case not to exceed the above mentioned soldering condition.
It is recommended to check the temperature rise of each portion under actual mounting condition before use.
2) Standard PC board terminal
Please meet the following conditions if this relay is to be automatically soldered.
(1) Preheating: Max. 120°C 248°F (terminal solder surface) for max. 120 seconds
(2) Soldering: Max. 260±5°C 500±9°F for max. 6 seconds
The effect on the relay depends on the actual substrate used. Please verify the substrate to be used.
Moisture-proof packaging enables RJ relay's standard PCB type capable for reflow soldering.
Please contact us in the case of reflow soldering considerations.
3) Hand soldering
Please meet the following conditions if this relay is to be soldered by hand.
(1) Wattage: 30 to 60 W
(2) Tip temperature/time: 280 to 300°C 536 to 572°F for max. 5 seconds
The effect on the relay depends on the actual substrate used. Please verify the substrate to be used.
4) Avoid high frequency cleaning since this may adversely affect relay characteristics. Use alcohol-based cleaning solutions when cleaning relays.

8. Measuring method (Impedance 50Ω)
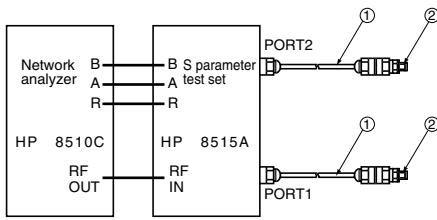
Connector

No.	Product name	Contents
1	HP 85131-60013	3.5 mm testport, Extension cable
2	HP 83059	3.5 mm coaxial adaptor

(Step 1) Calibrate the test system with HP calibration kit [HP85052B]
(Step 2) After calibration, connect the D.U.T. board and measure. Connect 50 Ω terminals on connectors other than those for measurement.
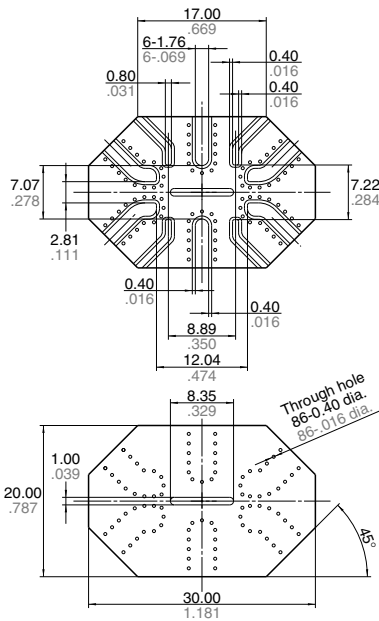
Notes:
1. All bottom surface of the base should be touched closely or soldered with PC board ground.
2. 4 ribs should be soldered with PC board ground.

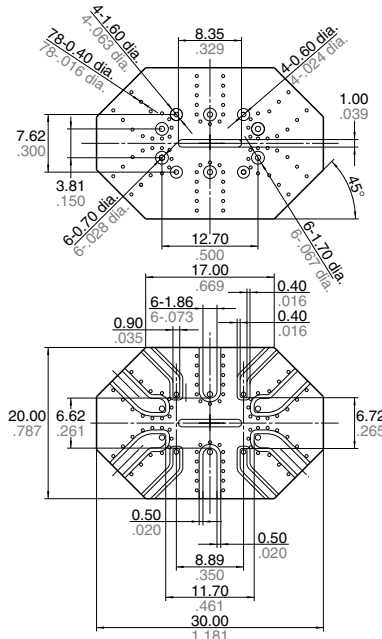### Measuring board

1) Dimensions
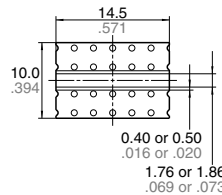<Surface mount terminal>

<Standard PC board terminal>

<Calibration board>

2) Material: Glass PTFE double-sided through hole PC board R-4737 (manufactured by our company)
3) Board thickness: t = 0.8 mm
4) Copper plating: 18μm
• Connector (SMA type receptacle)
Product name: R125 510 (RADIALL)
Insertion loss compensation
The insertion loss of relay itself is given by subtracting the insertion loss of short-circuit the Com and the NC (or NO). (signal path and two connectors)

9. Others

1) The switching lifetime is defined under the standard test condition specified in the JIS* C 5442-1996 standard (temperature 15 to 35°C 59 to 95°F, humidity 25 to 75%). Check this with the real device as it is affected by coil driving circuit, load type, activation frequency, activation phase, ambient conditions and other factors.
Also, be especially careful of loads such as those listed below.

• When used for AC load-operating and the operating phase is synchronous. Rocking and fusing can easily occur due to contact shifting.
• High-frequency load-operating
When high-frequency opening and closing of the relay is performed with a load that causes arcs at the contacts, nitrogen and oxygen in the air is fused by the arc energy and HNO_3 is formed. This can corrode metal materials.
Three countermeasures for these are listed here.
(1) Incorporate an arc-extinguishing circuit.
(2) Lower the operating frequency
(3) Lower the ambient humidity
2) Use the relay within specifications such as coil rating, contact rating and on/off service life. If used beyond limits, the relay may overheat, generate smoke or catch fire.
3) Be careful not to drop the relay. If accidentally dropped, carefully check its appearance and characteristics before use.
4) Be careful to wire the relay correctly. Otherwise, malfunction, overheat, fire or other trouble may occur.
5) If a relay stays on in a circuit for many months or years at a time without being activated, circuit design should be reviewed so that the relay can remain non-excited. A coil that receives current all the time heats, which degrades insulation earlier than expected. A latching type relay is recommended for such circuits.
6) The latching type relay is shipped in the reset position. But jolts during transport or impacts during installation can change the reset position. It is, therefore, advisable to build a circuit in which the relay can be initialized (set and reset) just after turning on the power.
7) If silicone materials (e.g., silicone rubbers, silicone oils, silicone coating agents, silicone sealers) are used in the vicinity of the relay, the gas emitted from the silicone may adhere to the contacts of the relay during opening and closing and lead to improper contact. If this is the case, use a material other than silicone.
8) We recommend latching type when using in applications which involve lengthy duty cycles.
* Japanese Industrial Standards

> **For general cautions for use, please refer to the "General Application Guidelines".**